

ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention

METHOD AND APPARATUS TO SEPARATE FIELD AND GRID
PARAMETERS ON FIRST LEVEL WAFERS

Application Number :

Confirmation Number:

First Named Applicant: Edward Conrad

Attorney Docket Number: BUR920030067US1







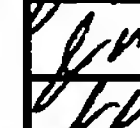


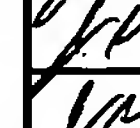





Art Unit:

Examiner:

Search string: (6557163 or 6528219 or 6498352 or 6436595 or 5763894 or 20030020889).pn




US Patent Documents

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass
	1	6557163	2003-04-29	Rankin et al.			
	2	6528219	2003-03-04	Conrad et al.			
	3	6498352	2002-12-24	Nishi			
	4	6436595	2002-08-20	Credendino et al.			
	5	5763894	1998-06-09	Enichen et al.			

US Published Applications


Note: Applicant is not required to submit a paper copy of cited US Published Applications

init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass
	1	20030020889	2003-01-30	Takahashi			

Signature

Examiner Name

Date


8/23/2005